Finite element based computation of beam coupling impedances



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Workshop Longitudinal Electron beam Dynamics for coherent Sources (LEDS'24)

September 17 – 20, 2024 Bern, Switzerland





Wakefield computation in the time domain



The wakefield problem in the time domain

$$W_{\parallel}(r,s) = \frac{1}{Q} \int dz \, E_z(r,z,t(s,z)) \qquad t(s,z) = \frac{s+z}{c}$$

- Solve time-dependent Maxwell's eqs. with beam current excitation
- Get impedance by Fourier transform

$$Z_{\parallel}(r,\omega) = -\frac{1}{c} \frac{1}{\tilde{\lambda}(\omega)} \int ds W_{\parallel}(r,s) \exp\left(-i\frac{\omega}{c}s\right)$$

- For short-range wakes: moving window / dispersion-free computation



PBCI simulation: wakefield in a TESLA cavity

E. Gjonaj et al.,ICAP'06, MOM2IS02



Wakefield computation in the time domain



LHC RF-Fingers





Contents



- A high order FE method for beam impedance computations
- Shielded CSR wakes
- Generalized S-Matrix formulation
- Lumped model cavity optimization
- Including external loads
- Domain decomposition approach





The frequency domain problem

 $\nabla \times \mu^{-1} \nabla \times E - k_0^2 \varepsilon E = -jk_0 Z_0 J_s \qquad J_s(x, y, z, \omega) = \delta(x - x_0) \delta(y - y_0) e^{-i\frac{\omega}{\nu}z}$

• Weak formulation: find $E \in H(curl)^*$ such that:

$$\int dV \mu^{-1} \nabla \times E \cdot \nabla \times v_h - k_0^2 \int dV \varepsilon E \cdot v_h = -jk_0 Z_0 \int dV J_s \cdot v_h$$







Treatment of boundary surfaces

$$\int dV \mu^{-1} \nabla \times E \cdot \nabla \times v_h - k_0^2 \int dV \varepsilon E \cdot v_h =$$

$$-jk_0 Z_0 \int dV J_s \cdot v_h + \int_{S_{SIBC}} dS n \cdot [v_h \times \mu^{-1} \nabla \times E] + \int_{S_{WG}} dS n \cdot [v_h \times \mu^{-1} \nabla \times E]$$
resistive wall in & outgoing pipes

Surface impedance

$$\oint_{S_{SIBC}} dS \ n \cdot [v_h \times \mu^{-1} \nabla \times E] = \dots = j \omega \boldsymbol{Y}_{\boldsymbol{S}}(\boldsymbol{\omega}) \oint_{S_{SIBC}} dS \ v_h \cdot [n \times n \times E]$$

- Simple modification of the system matrix on SIBC surfaces
- No fitting of the surface impedance function or ADE/convolution is needed





Treatment of boundary surfaces

$$\int dV \mu^{-1} \nabla \times E \cdot \nabla \times v_h - k_0^2 \int dV \varepsilon E \cdot v_h = -jk_0 Z_0 \int dV J_s \cdot v_h + \int_{S_{SIBC}} dS n \cdot [v_h \times \mu^{-1} \nabla \times E] + \int_{S_{WG}} dS n \cdot [v_h \times \mu^{-1} \nabla \times E]$$
resistive wall in & outgoing pipes

Beam pipes





Hybrid meshes – collimator example







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Hybrid meshes – collimator example



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Shielded CSR wakes



DESY-EuXFEL bunch compressor (BC1)





Shielded CSR wakes



DESY-EuXFEL bunch compressor (BC1)





Generalized S-Matrix



Scattering matrix with beam:

$$\begin{pmatrix} S_{11} & S_{12} \\ S_{21} & S_{22} \end{pmatrix} \begin{pmatrix} a_1 \\ a_2 \end{pmatrix} = \begin{pmatrix} b_1 \\ b_2 \end{pmatrix} \quad \Rightarrow \quad \left[\begin{pmatrix} \tilde{S} & \tilde{k} \\ \tilde{h} & Z_b \end{pmatrix} \begin{pmatrix} a_m \\ i_b \end{pmatrix} = \begin{pmatrix} b_m \\ u_b \end{pmatrix} \right]$$

- Concatenation of cascaded structures:

Matching conditions:





Generalized S-Matrix



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Tesla 1.3GHz cavity





Generalized S-Matrix



Tesla 1.3GHz cavity





Lumped model cavity optimization



SPS 44-cell 200MHz TW cavities





Including termination loads







Including termination loads



SPS 33-cell 200 MHz TW-structure









Domain decomposition



Example: IVU for PETRA III/IV
 vacuum chamber
 magnets
 4.6 m
 tapered beam pipe

Order	# DoFs	Order	# DoFs
0	0.9e6	3	19e6
1	2e6	4	38e6
2	7e6	5	

- Multiple trapped modes at 0.1-1GHz
- High-Q dominated by wall losses
- Local heat spots / surface fields
- ~1500GB RAM
- ~ weeks of CPU-time



Domain decomposition



Decompose geometry by suitable boundary conditions



$$F_{12}^{\text{out}} = \underbrace{\mathcal{S}(n_1 \times n_1 \times E_1') + n_1 \times (\nabla \times E_1')}_{\text{absorbing operator}} + \underbrace{n_1 \times (\nabla \times E_1')}_{\text{one-way wave operator}} = \underbrace{\mathcal{S}(n_2 \times n_2 \times E_2') - n_2 \times (\nabla \times E_2')}_{\text{one-way wave operator}} = F_{21}^{\text{in}} \quad \text{on} \quad \Gamma_{12}$$

with iteration prescription: $\begin{cases} F_{21}^{in}(n+1) = F_{12}^{out}(n) \\ F_{12}^{in}(n+1) = F_{21}^{out}(n) \end{cases}$ (using fixed-point or a Krylov iteration)

Apply TC using waveguide port operator*: $F_{12}^{out} = P(E_1 - E_1^{inc}) + n_1 \times (\nabla \times (E_1 - E_1^{inc}))$

*Gionaj, et al.: IPAC'24, THPC62



Domain decomposition







Summary & Conclusions



- The Finite-Element-Frequency-Domain approach
 - Fills the gap for some important wakefield / impedance problems
 - Complicated chamber geometries
 - Resonant structures \rightarrow long-range wakefields
 - Resistive, rough surfaces, dispersive materials, waveguide openings
 - Curved beam trajectories and CSR
 - Allows lumped parameter modeling
 - Concatenation of large structures by generalized S-Matrix
 - Fast cavity impedance optimization including termination loads
 - Quasi-periodic THz structures
 - Limitation: huge size of 3D discrete problems for ultra-high frequencies
 - Parallel iterative solvers by non-overlapping DDM

